

COMPLEMENTARY NPN / PNP SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features & Benefits

• Complementary Pairs One 2222A Type (NPN)

One 2907A Type (PNP)

- Ideal for Low Power Amplification and Switching
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

Case: SOT363

 Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020

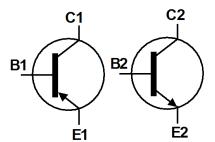
 Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208

Weight: 0.006 grams (approximate)

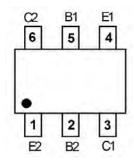








Device Symbol



Top View Pin-Out

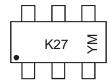
Ordering Information (Note 4)

| í | | | | | |
|---|--------------|---------|--------------------|-----------------|-------------------|
| | Product | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
| | MMDT2227-7-F | K27 | 7 | 8 | 3,000 |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



K27 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: X = 2010) M = Month (ex: 9 = September)

Date Code Key

| Year | 2010 | 20 | 011 | 2012 | 2 | 2013 | 2014 | | 2015 | 2016 | | 2017 |
|-------|------|-----|-----|------|-----|------|------|-----|------|------|-----|------|
| Code | Χ | | Υ | Z | | Α | В | | С | D | | Е |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |

MMDT2227 Document Number: DS30122 Rev: 12 - 2 1 of 6

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Maximum Ratings, 2222A Type (NPN) (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|------------------------------|------------------|-------|------|
| Collector-Base Voltage | V _{CBO} | 75 | V |
| Collector-Emitter Voltage | V_{CEO} | 40 | V |
| Emitter-Base Voltage | V_{EBO} | 6 | V |
| Continuous Collector Current | lc | 600 | mA |

Maximum Ratings, 2907A Type (PNP) (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|------------------------------|------------------|-------|------|
| Collector-Base Voltage | V _{CBO} | -60 | V |
| Collector-Emitter Voltage | V _{CEO} | -60 | V |
| Emitter-Base Voltage | V _{EBO} | -6.0 | V |
| Continuous Collector Current | Ic | -600 | mA |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit |
|---|----------------|-----------------------------------|-------------|------|
| Power Dissipation | (Notes 5) | P_{D} | 200 | mW |
| Thermal Resistance, Junction to Ambient | $R_{	hetaJA}$ | 625 | °C/W | |
| Thermal Resistance, Junction to Case | $R_{	heta JC}$ | 150 | -C/VV | |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -55 to +150 | °C |

Notes:

^{5.} Device mounted on 1 inch x 0.85 inch x 0.062 inch FR-4 PCB

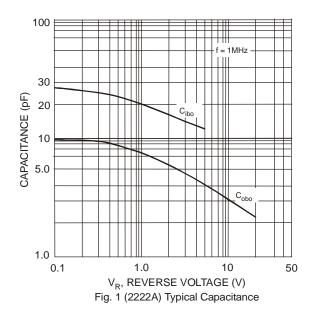
^{6.} Thermal resistance from junction to the top of package

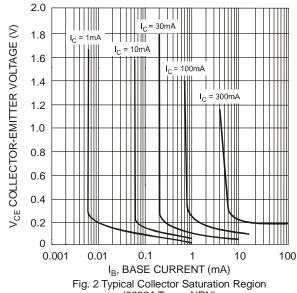


Electrical Characteristics, 2222A Type (NPN) (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Max | Unit | Test Condition | |
|--------------------------------------|----------------------|---|------------|----------|---|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | |
| Collector-Base Breakdown Voltage | BV _{CBO} | 75 | _ | V | $I_C = 100 \mu A, I_E = 0$ | |
| Collector-Emitter Breakdown Voltage | BV _{CEO} | 40 | | V | $I_C = 10 \text{mA}, I_B = 0$ | |
| Emitter-Base Breakdown Voltage | BV _{EBO} | 6.0 | | V | $I_E = 100 \mu A, I_C = 0$ | |
| Collector Cutoff Current | Ісво | | 10 | nA μA | $V_{CB} = 60V, I_{E} = 0$ $V_{CB} = 60V, I_{E} = 0, T_{A} = +150^{\circ}C$ | |
| Collector Cutoff Current | I _{CEX} | _ | 10 | nA | $V_{CE} = 60V, V_{EB(off)} = 3.0V$ | |
| Emitter Cutoff Current | I _{EBO} | | 10 | nA | V _{EB} = 5.0V, I _C = 0 | |
| Base Cutoff Current | I _{BL} | _ | 20 | nA | $V_{CE} = 60V, V_{EB(off)} = 3.0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | , , , , , , , , , , , , , , , , , , , | |
| DC Current Gain | h _{FE} | 35 50 75 100 40 50 35 | 300 | _ | $\begin{array}{ll} I_{C} = 100 \mu A, \ V_{CE} = 10 V \\ I_{C} = 1.0 mA, \ V_{CE} = 10 V \\ I_{C} = 10 mA, \ V_{CE} = 10 V \\ I_{C} = 150 mA, \ V_{CE} = 10 V \\ I_{C} = 500 mA, \ V_{CE} = 10 V \\ I_{C} = 10 mA, \ V_{CE} = 10 V, \ T_{A} = -55 ^{\circ} C \\ I_{C} = 150 mA, \ V_{CE} = 1.0 V \end{array}$ | |
| Collector-Emitter Saturation Voltage | V _{CE(sat)} | _ | 0.3 1.0 | V | $I_C = 150$ mA, $I_B = 15$ mA $I_C = 500$ mA, $I_B = 50$ mA | |
| Base-Emitter Saturation Voltage | V _{BE(sat)} | 0.6 | 1.2 2.0 | V | I _C = 150mA, I _B = 15mA I _C = 500mA, I _B = 50mA | |
| SMALL SIGNAL CHARACTERISTICS | | | | | | |
| Output Capacitance | C _{obo} | | 8 | pF | $V_{CB} = 10V, f = 1.0MHz, I_{E} = 0$ | |
| Input Capacitance | C _{ibo} | _ | 25 | pF | $V_{EB} = 0.5V$, $f = 1.0MHz$, $I_{C} = 0$ | |
| Current Gain-Bandwidth Product | f⊤ | 300 | | MHz | $V_{CE} = 20V$, $I_C = 20mA$, $f = 100MHz$ | |
| Noise Figure | NF | | 4.0 | dB | $V_{CE} = 10V, I_{C} = 100\mu A,$ $R_{S} = 1.0k\Omega, f = 1.0kHz$ | |
| SWITCHING CHARACTERISTICS | | | | | | |
| Delay Time | t _d | | 10 | ns | $V_{CC} = 30V, I_C = 150mA,$ | |
| Rise Time | t _r | _ | 25 | ns | $V_{BE(off)} = -0.5V, I_{B1} = 15mA$ | |
| Storage Time | ts | _ | 225 | ns | $V_{CC} = 30V, I_C = 150mA,$ | |
| Fall Time | t _f | _ | 60 | ns | $I_{B1} = I_{B2} = 15mA$ | |

7. Pulse test: Pulse width $\leq 300 \mu s$, duty cycle $\leq 2\%$. Notes:



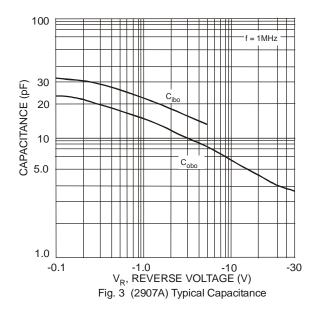


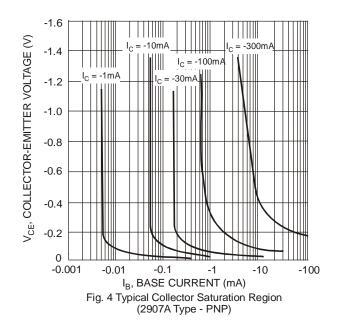


Electrical Characteristics, 2907A Type (PNP) (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Max | Unit | Test Condition | |
|--------------------------------------|----------------------|------|------|------|---|--|
| OFF CHARACTERISTICS (Note 8) | | | | | | |
| Collector-Base Breakdown Voltage | BV _{CBO} | -60 | | V | $I_C = -100 \mu A, I_E = 0$ | |
| Collector-Emitter Breakdown Voltage | BV _{CEO} | -60 | | ٧ | $I_C = -10 \text{mA}, I_B = 0$ | |
| Emitter-Base Breakdown Voltage | BV _{EBO} | -6.0 | | V | $I_E = -100 \mu A, I_C = 0$ | |
| Collector Cutoff Current | lone | | -10 | nA | $V_{CB} = -50V, I_{E} = 0$ | |
| | Ісво | | | μΑ | $V_{CB} = -50V, I_E = 0, T_A = +125^{\circ}C$ | |
| Collector Cutoff Current | I _{CEX} | | -50 | nA | $V_{CE} = -30V, V_{EB(off)} = -0.5V$ | |
| Base Cutoff Current | I_{BL} | _ | -50 | nA | $V_{CE} = -30V, V_{EB(off)} = -0.5V$ | |
| ON CHARACTERISTICS (Note 8) | | | | | | |
| | | 75 | _ | | $I_C = -100 \mu A, V_{CE} = -10 V$ | |
| | h _{FE} | 100 | _ | _ | $I_C = -1.0 \text{mA}, V_{CE} = -10 \text{V}$ | |
| DC Current Gain | | 100 | _ | | $I_C = -10 \text{mA}, V_{CE} = -10 \text{V}$ | |
| | | 100 | 300 | | $I_C = -150 \text{mA}, V_{CE} = -10 \text{V}$ | |
| | | 50 | | | $I_C = -500 \text{mA}, V_{CE} = -10 \text{V}$ | |
| Collector-Emitter Saturation Voltage | V _{CE(sat)} | _ | -0.4 | V | $I_C = -150 \text{mA}, I_B = -15 \text{mA}$ | |
| Collector-Emitter Saturation Voltage | | | -1.6 | | $I_C = -500 \text{mA}, I_B = -50 \text{mA}$ | |
| Base-Emitter Saturation Voltage | V _{BE(sat)} | | -1.3 | V | $I_C = 150 \text{mA}, I_B = 15 \text{mA}$ | |
| | VBE(sat) | | -2.6 | v | $I_C = 500 \text{mA}, I_B = 50 \text{mA}$ | |
| SMALL SIGNAL CHARACTERISTICS | | | | | | |
| Output Capacitance | C _{obo} | | 8.0 | pF | $V_{CB} = -10V$, $f = 1.0MHz$, $I_E = 0$ | |
| Input Capacitance | C _{ibo} | _ | 30 | pF | $V_{EB} = -2.0V$, $f = 1.0MHz$, $I_{C} = 0$ | |
| Current Gain-Bandwidth Product | f _T | 200 | | MHz | $V_{CE} = -20V, I_{C} = -50mA,$ f = 100MHz | |
| SWITCHING CHARACTERISTICS | | | | | | |
| Turn-On Time | t _{on} | | 45 | ns | _ | |
| Delay Time | t _d | _ | 10 | ns | $V_{CC} = -30V, I_{C} = -150mA,$ | |
| Rise Time | t _r | | 40 | ns | $I_{B1} = -15 \text{mA}$ | |
| Turn-Off Time | t _{off} | _ | 100 | ns | _ | |
| Storage Time | t _s | | 80 | ns | $V_{CC} = -6.0V$, $I_{C} = -150mA$, | |
| Fall Time | t _f | | 30 | ns | $I_{B1} = I_{B2} = -15 \text{mA}$ | |

Notes: 8. Short duration pulse test used to minimize self-heating effect.

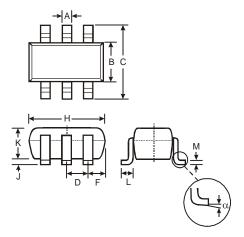






Package Outline Dimensions

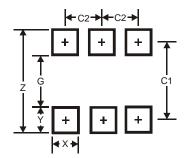
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| | SOT363 | | | | | | | | |
|-----|-----------|---------|-------|--|--|--|--|--|--|
| Dim | Min | Max | Тур | | | | | | |
| Α | 0.10 | 0.30 | 0.25 | | | | | | |
| В | 1.15 | 1.35 | 1.30 | | | | | | |
| С | 2.00 | 2.20 | 2.10 | | | | | | |
| D | 0.65 Typ | | | | | | | | |
| F | 0.40 | 0.45 | 0.425 | | | | | | |
| Н | 1.80 2.20 | | 2.15 | | | | | | |
| J | 0 | 0.10 | 0.05 | | | | | | |
| K | 0.90 | 1.00 | 1.00 | | | | | | |
| L | 0.25 | 0.40 | 0.30 | | | | | | |
| M | 0.10 | 0.22 | 0.11 | | | | | | |
| α | 0° | 8° | - | | | | | | |
| All | Dimen | sions i | n mm | | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.5 |
| G | 1.3 |
| Х | 0.42 |
| Υ | 0.6 |
| C1 | 1.9 |
| C2 | 0.65 |

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